



Appl. No. : 10/036,796  
Applicant : Driscoll et al.  
Filed : 01/07/2002

Confirmation No.: 4854

Title : High-Speed, High Density Interconnect System ...

TC/A.U. : 2833  
Examiner : Xuong M. Chung Trans

Docket : 2885-118 (formerly 3395-089)  
Cust. No. : 6449

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

Date: March 12, 2004

**REPLY TO OFFICE ACTION**

Dear Sir:

This Reply is in response to the Office Action mailed on  
December 4, 2003.

**Amendments to the claims** are reflected in the listing of  
claims which begins on page 2 of this paper.

**Remarks** begin on page 13 of this paper.

04/02/2004 SMINASS1 00000032 10036796

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